



# ENG-E25-081 - Distributors

JAE Electronics, Inc.  
June 25<sup>th</sup>, 2025

## PCN (Process Change Notice) MX77S13K4F1\_MX77S13K4F2\_MX77S13K5F1 Additional Stamp Die To Keep Production Capacity

Part Number	1 Existing Stamp Die	1 Additional Stamp Die Will Be Created	Additional Stamp Die Completion	Proposed PPAP Submission	Start of Mass Production (SOP)
MX77S13K4F1 MX77S13K4F2 MX77S13K5F1	564714-001	564714-003	July 2025	November 2025	January 2026

### Notes:

- PC = Process Change (Tooling: Transfer, Replacement, Refurbishment, or additional and Parts Produced at Additional Location, etc...)
- PPAP = Production Part Approval Process

1. PC PPAP will only be prepared and provided to customer who already received and provided initial PPAP approval.
2. If you request PPAP documents for this notification, please notify us ASAP.